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ON Semiconductor® FQB47P06 P-Channel QFET[®] MOSFET

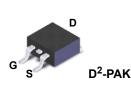
-60 V, -47 A, 26 mΩ

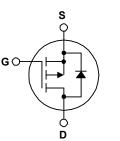
Description

This P-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 47 A, -60 V, $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ = 26 m Ω (Max.) @ V_{\mathsf{GS}} = .10 V, I_D = -23.5 A
- Low Gate Charge (Typ. 84 nC)
- Low Crss (Typ. 320 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter	FQB47P06TM-AM002	Unit	
V _{DSS}	Drain-Source Voltage	-60	V	
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		-47	А
	- Continuous (T _C = 100°C)		-33.2	А
I _{DM}	Drain Current - Pulsed	(Note 1)	-188	А
V _{GSS}	Gate-Source Voltage	± 25	V	
E _{AS}	Single Pulsed Avalanche Energy (Note		820	mJ
I _{AR}	Avalanche Current	(Note 1)	-47	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	16	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		-7.0	V/ns
P _D	Power Dissipation $(T_A = 25^{\circ}C)^{*}$	3.75	W	
	Power Dissipation ($T_C = 25^{\circ}C$)	160	W	
	- Derate above 25°C	1.06	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +175	°C	
TL	Maximum lead temperature for soldering, 1/8" from case for 5 seconds	300	°C	

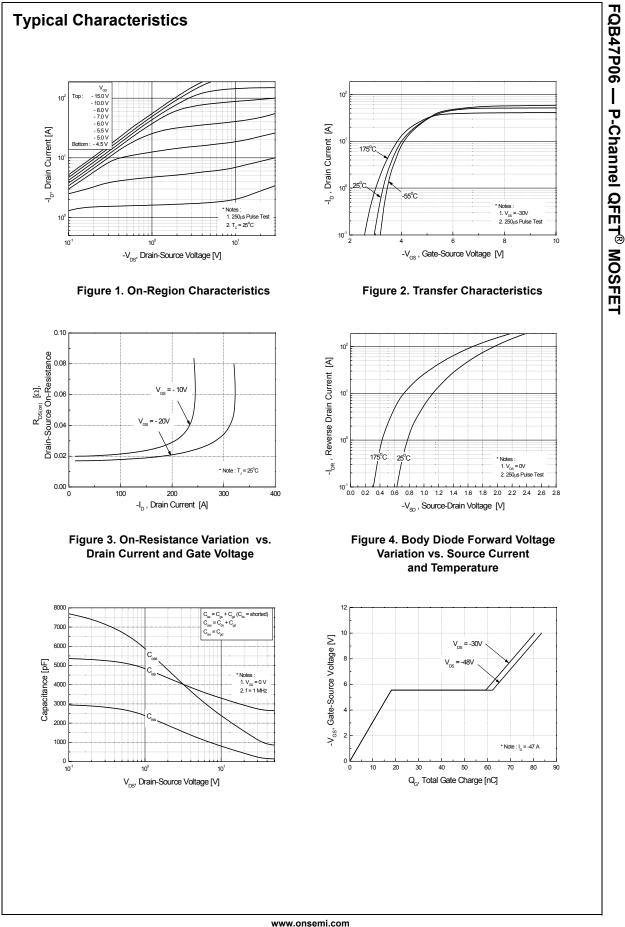
Thermal Characteristics

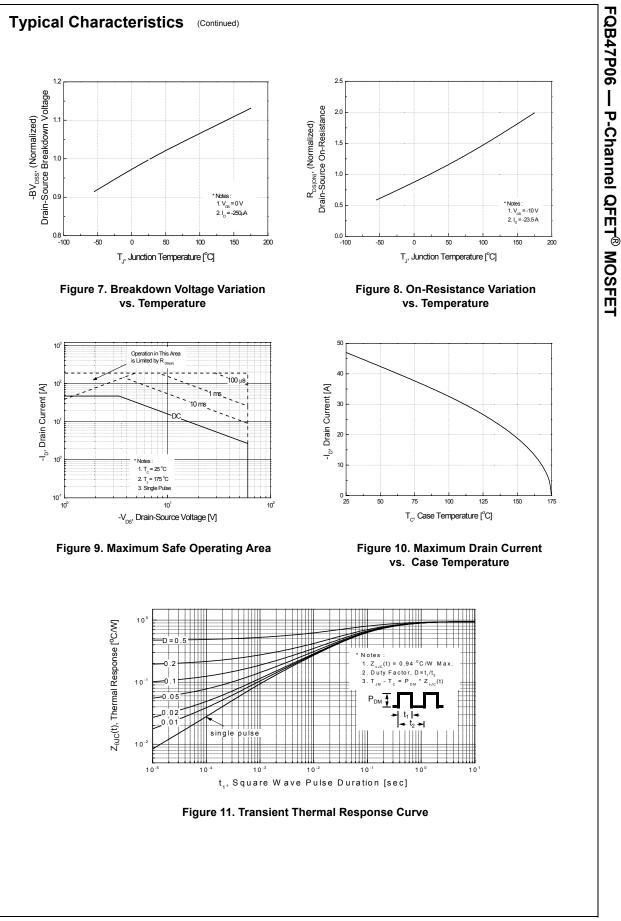
Symbol	Parameter	FQB47P06TM-AM002	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.94	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	40	

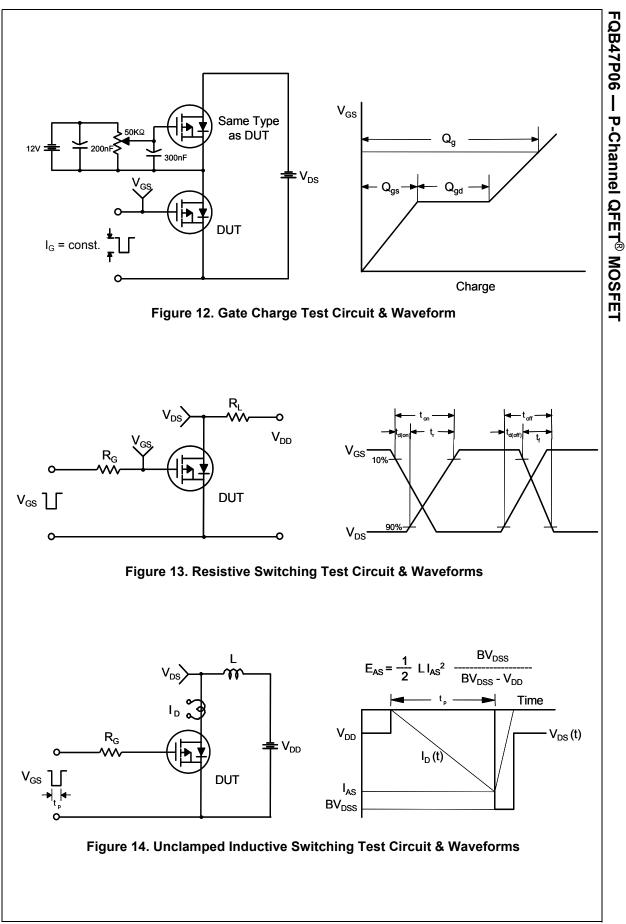
FQB47P06 — P-Channel QFET[®] MOSFET

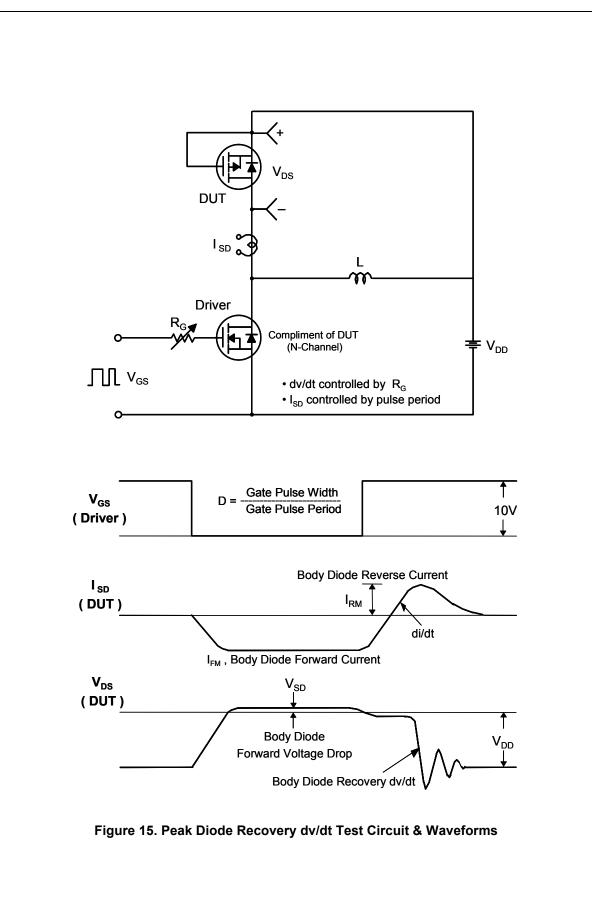
Part Number FQB47P06TM-AM002		Top Mark	Pack	kage Packing Method Reel S		Size	Tape Width		Quantity	
		FQB47P06		² -PAK Tape and Reel 330		mm	24 mm		800 units	
lectri	cal Chara	cteristics	T _C = 25°C (unless oth	erwise noted.					
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Cha	aracteristics	5								
3V _{DSS}	Drain-Source	Breakdown Voltag	ge	V _{GS} =	0 V, I _D = -250 μA		-60			V
∆BV _{DSS} ∆Tj	Breakdown Voltage Temperature Coefficient		re	I_D = -250 µA, Referenced to 25°C				-0.06		V/°C
DSS	Zero Gate Voltage Drain Current			V _{DS} = -60 V, V _{GS} = 0 V					-1	μA
200			nt –	$V_{DS} = -48 \text{ V}, T_{C} = 150^{\circ}\text{C}$					-10	μA
GSSF	Gate-Body Le	eakage Current, Fo	orward	V _{GS} =	-25 V, V _{DS} = 0 V				-100	nA
GSSR		eakage Current, R			25 V, V _{DS} = 0 V				100	nA
On Cha	racteristics	5								
/ _{GS(th)}	Gate Thresho	old Voltage		V _{DS} =	V _{GS} , I _D = -250 μA		-2.0		-4.0	V
R _{DS(on)}	Static Drain-S On-Resistance			V _{GS} = -10 V, I _D = -23.5 A				0.021	0.026	Ω
Ĵfs	Forward Tran	sconductance		V _{DS} =	-30 V, I _D = -23.5 A			21		S
Piss Poss	ic Characte Input Capacit Output Capa	ance citance		V _{DS} = - f = 1.0	-25 V, V _{GS} = 0 V, MHz			2800 1300	3600 1700	pF pF
Srss	Reverse Tran	sfer Capacitance						320	420	pF
	ing Charact							1		
d(on)	Turn-On Dela	,		V _{DD} =	-30 V, I _D = -23.5 A,			50	110	ns
r	Turn-On Rise			R _G = 2	5Ω			450	910	ns
d(off)	Turn-Off Dela	,						100	210	ns
-	Turn-Off Fall					(Note 4)		195	400	ns
ζ _g	Total Gate Ch	0			-48 V, I _D = -47 A,			84	110	nC
2 _{gs}	Gate-Source	0		V _{GS} =				18		nC
2 _{gd}	Gate-Drain C	harge				(Note 4)		44		nC
Drain-S	ource Diod	le Characteris	tics and	d Max	imum Ratings					
S		ntinuous Drain-So							-47	Α
SM	Maximum Pu	Ised Drain-Source							-188	Α
/ _{SD}	Drain-Source	Diode Forward Vo	-		0 V, I _S = -47 A				-4.0	V
r	Reverse Rec	overy Time		00	0 V, I _S = -47 A,			130		ns
ג. גיי	Reverse Rec	overy Charge		dl _F / dt	= 100 A/μs			0.55		μC
L = 0.43 ml		imited by maximum junc = -25 V, R _G = 25 Ω, star	ting $T_J = 25^{\circ}$							

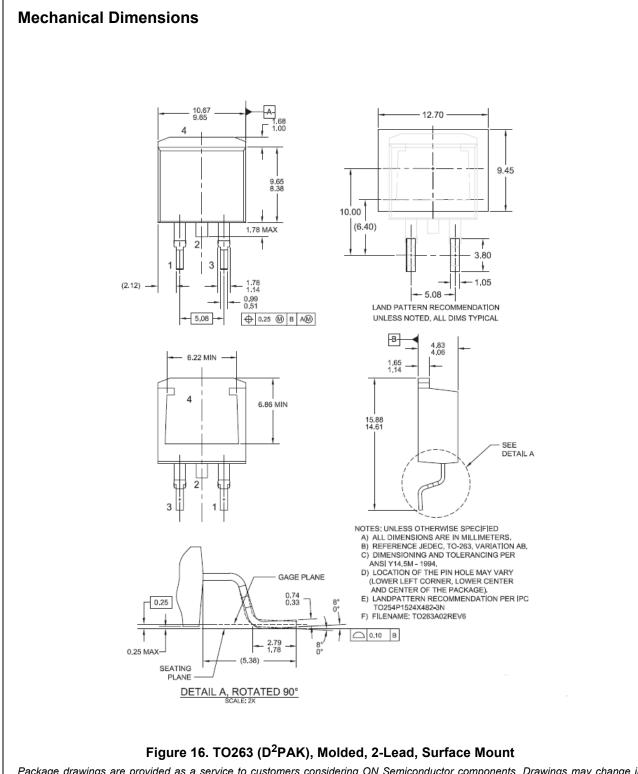
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